

#### 4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

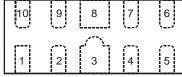
#### **Features**

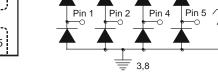
- Clamping Voltage: 9V at 10A 100ns TLP; 9V at 6A 8µs/20µs
- IEC 61000-4-2 (ESD): Air +20/-18kV, Contact +20/-16kV
- IEC 61000-4-5 (Lightning): ±6A (8/20µs)
- 4 Channels of ESD Protection
- Low Channel Input Capacitance of 0.5pF Typical
- TLP Dynamic Resistance: 0.25Ω
- Typically Used for High Speed Ports Such as USB 2.0, DVI<sup>™</sup>, HDMI<sup>™</sup>, Ethernet Port, IEEE, MDDI, PCI Express<sup>®</sup>, SATA/ eSATA
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: U-DFN2510-10
- Case Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe (Lead-Free Plating)
   Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.038 grams (Approximate)

Pin#	Description			
1, 2, 4, 5	I/O			
6, 7, 9, 10	No Connection			
3. 8	Vec			





Pin Description (Top View)

**Device Schematic** 

#### Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DT1140-04LP-7	AEC-Q101	BC2	7	8	3,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**

U-DFN2510-10

BC2 YM

BC2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	20	13	20	14	20	15	20	16	20	17	20	18
Code	A	4	E	3	(	)		)	[		F	
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	I <sub>PP</sub>	6	Α	I/O to V <sub>SS</sub> , 8/20µs
Peak Pulse Power, per IEC 61000-4-5	P <sub>PP</sub>	60	W	I/O to V <sub>SS</sub> , 8/20µs
Operating Voltage (DC)	$V_{DC}$	6	V	I/O to V <sub>SS</sub>
ESD Protection – Contact Discharge, per IEC 61000-4-2	V <sub>ESD_</sub> CONTACT	+20/-16	kV	I/O to V <sub>SS</sub>
ESD Protection – Air Discharge, per IEC 61000-4-2	V <sub>ESD_AIR</sub>	+20/-18	kV	I/O to V <sub>SS</sub>
Operating Temperature	T <sub>OP</sub>	-55 to +85	°C	_
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C	_

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	P <sub>D</sub>	350	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	$R_{ hetaJA}$	360	°C/W

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	$V_{RWM}$	_	_	5.5	V	I <sub>R</sub> =1mA, , I/O to V <sub>SS</sub>
Reverse Current (Note 6)	I <sub>R</sub>	_	_	50	nA	$V_R = 5V$ , I/O to $V_{SS}$
Reverse Breakdown Voltage	$V_{BR}$	6	_	_	V	I <sub>R</sub> = 1mA, I/O to V <sub>SS</sub>
Forward Clamping Voltage	V <sub>F</sub>	-1.0	-0.85	_	V	$I_F = -15$ mA, I/O to $V_{SS}$
Holding Voltage	V <sub>H</sub>	5.5	_	_	V	_
Reverse Clamping Voltage (Note 7)	Vc	_	6.4	_	V	I <sub>PP</sub> = 1A, I/O to V <sub>SS</sub> , 8/20μs
Reverse Clamping Voltage (Note 7)	Vc	_	9	10	V	$I_{PP} = 6A$ , I/O to $V_{SS}$ , 8/20 $\mu$ s
Trigger Voltage	$V_{TRIG}$	_	_	9.5	V	_
ESD Clamping Voltage	V <sub>ESD</sub>	_	9	_	V	TLP, 10A, $t_P = 100$ ns, I/O to $V_{SS}$
Dynamic Reverse Resistance	R <sub>DIF-R</sub>	_	0.25	_	Ω	TLP, 10A, $t_P = 100$ ns, I/O to $V_{SS}$
Dynamic Forward Resistance	R <sub>DIF-F</sub>	_	0.25	_	Ω	TLP, 10A, t <sub>P</sub> = 100ns, V <sub>SS</sub> to I/O
Channel Input Capacitance	C <sub>I/O</sub>	_	0.5	0.65	pF	$V_{I/O} = 2.5V, V_{SS} = 0V, f = 1MHz$

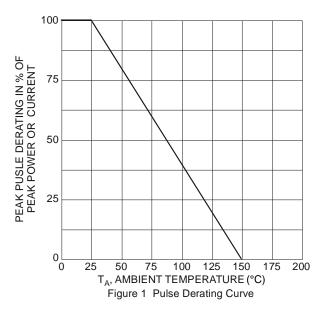
Notes:

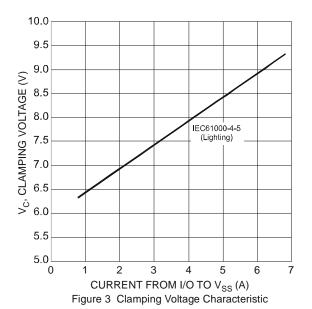
<sup>5.</sup> Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

<sup>6.</sup> Short duration pulse test used to minimize self-heating effect.

<sup>7.</sup> Clamping voltage value is based on an  $8x20\mu s$  peak pulse current ( $I_{pp}$ ) waveform.







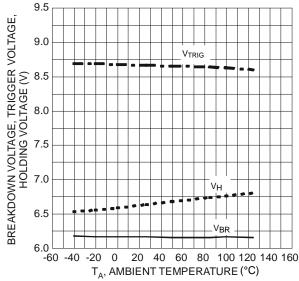


Figure 2 BV, Trigger Voltage, Holding Voltage vs. Ambient Temperature

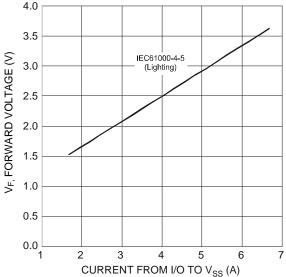
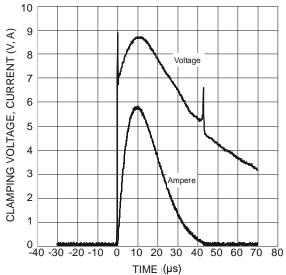
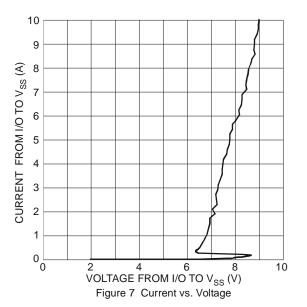


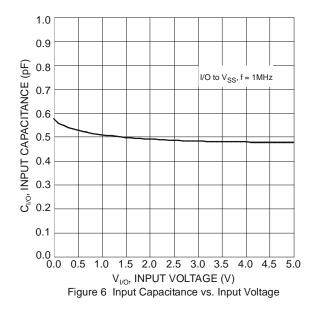
Figure 4 Forward Voltage Characteristic





TIME (µs)
Figure 5 Waveform of Clamping Voltage,
Current vs. Time (8/20µs, I/O to V<sub>SS</sub>)



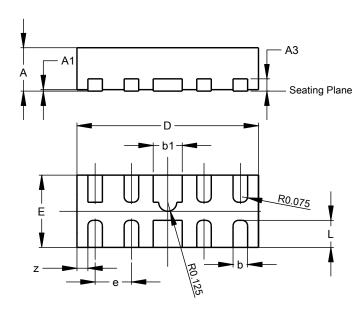




### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2510-10

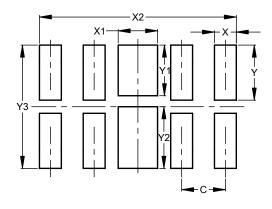


U-DFN2510-10							
Dim	Min	Max	Тур				
Α	0.545	0.605	0.575				
A1	0.00	0.05	0.03				
А3	-	-	0.13				
b	0.15	0.25	0.20				
b1	0.35	0.45	0.40				
D	2.450	2.575	2.500				
е	-	-	0.50				
Е	0.950	1.075	1.000				
L	0.325	0.425	0.375				
Z	-	-	0.150				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2510-10



Dimensions	Value (in mm)
С	0.500
Х	0.250
X1	0.450
X2	2.250
Υ	0.625
Y1	0.575
Y2	0.700
Y3	1.400



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